

February 2010

# FGPF4633 330V PDP IGBT

### **Features**

- · High current capability
- Low saturation voltage: V<sub>CE(sat)</sub> = 1.55 V @ I<sub>C</sub> = 70A
- High input impedance
- Fast switching
- · RoHS compliant

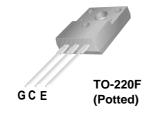
## **Applications**

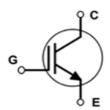
PDP System



## **General Description**

Using Novel Trench IGBT Technology, Fairchild's new series of trench IGBTs offer the optimum performance for PDP applications where low conduction and switching losses are essential.





## **Absolute Maximum Ratings**

Symbol	Description		Ratings	Units	
V <sub>CES</sub>	Collector to Emitter Voltage		330	V	
V <sub>GES</sub>	Gate to Emitter Voltage		± 30	V	
I <sub>C pulse(1)*</sub>	Collector Current	$@ T_C = 25^{\circ}C$	300	А	
P <sub>D</sub>	Maximum Power Dissipation	$@ T_C = 25^{\circ}C$	30.5	W	
	Maximum Power Dissipation	$@ T_C = 100^{\circ}C$	12.2	W	
T <sub>J</sub>	Operating Junction Temperature		-55 to +150	°C	
T <sub>stg</sub>	Storage Temperature Range		-55 to +150		
T <sub>L</sub>	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

## **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Units	
$R_{\theta JC}(IGBT)$	Thermal Resistance, Junction to Case	-	4.1	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	-	62.5	°C/W	

#### Notes:

(1) Half Sine Wave, D < 0.01, pluse width < 5µsec

<sup>\*</sup> lc\_pluse limited by max Tj

# **Package Marking and Ordering Information**

Device Marking Device		Package	Packaging Type	Qty per Tube	Max Qty per Box
FGPF4633	FGPF4633TU	TO-220F	Tube	50ea	-

# Electrical Characteristics of the IGBT $T_C = 25$ °C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Charac	eteristics					
BV <sub>CES</sub>	Collector to Emitter Breakdown Voltage	$V_{GE} = 0V, I_{C} = 250\mu A$	330	-	-	V
$\frac{\Delta BV_{CES}}{\Delta T_{J}}$	Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0V, I_{C} = 250\mu A$	-	0.3	-	V/°C
I <sub>CES</sub>	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$	-	-	100	μΑ
$I_{GES}$	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$	-	-	±400	nA
On Charac	eteristics					
V <sub>GE(th)</sub>	G-E Threshold Voltage	$I_{C} = 250 \mu A, V_{CE} = V_{GE}$	2.4	3.3	4.0	V
- (-,		I <sub>C</sub> = 20A, V <sub>GE</sub> = 15V	-	1.1	-	V
V	Collector to Emitter	I <sub>C</sub> = 40A, V <sub>GE</sub> = 15V	-	1.35	-	
CL(Sat)	Saturation Voltage	$I_C = 70A$ , $V_{GE} = 15V$ , $T_C = 25^{\circ}C$	-	1.55	1.8	V
		$I_C = 70A, V_{GE} = 15V,$ $T_C = 125^{\circ}C$	-	1.61	-	V
Dynamic C	Characteristics					
C <sub>ies</sub>	Input Capacitance		-	1715	-	pF
C <sub>oes</sub>	Output Capacitance	$V_{CE} = 30V_{,} V_{GE} = 0V_{,}$ f = 1MHz	-	75	-	pF
C <sub>res</sub>	Reverse Transfer Capacitance	1 - 11VII 12	-	55	-	pF
Switching	Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time		-	8	-	ns
t <sub>r</sub>	Rise Time	$V_{CC}$ = 200V, $I_{C}$ = 20A $R_{G}$ = 5 $\Omega$ , $V_{GE}$ = 15V Resistive Load, $T_{C}$ = 25°C	-	30	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	52	-	ns
t <sub>f</sub>	Fall Time		-	260	-	ns
t <sub>d(on)</sub>	Turn-On Delay Time		-	8	-	ns
t <sub>r</sub>	Rise Time	$V_{CC}$ = 200V, $I_{C}$ = 20A, $R_{G}$ = 5 $\Omega$ , $V_{GE}$ = 15V, Resistive Load, $T_{C}$ = 125°C	-	32	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	53	-	ns
t <sub>f</sub>	Fall Time		-	341	-	ns
Qg	Total Gate Charge	V <sub>CE</sub> = 200V, I <sub>C</sub> = 20A	-	60	-	nC
Q <sub>ge</sub>	Gate to Emitter Charge	V <sub>GE</sub> = 200 V, I <sub>C</sub> = 20A	-	8	-	nC
$Q_{gc}$	Gate to Collector Charge		-	20	-	nC

Figure 1. Typical Output Characteristics

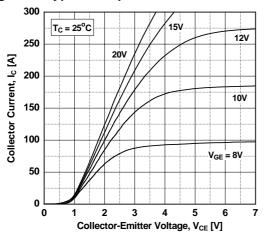


Figure 3. Typical Saturation Voltage Characteristics

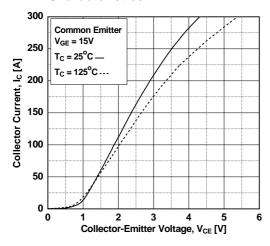
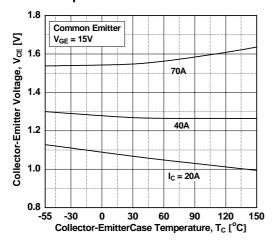
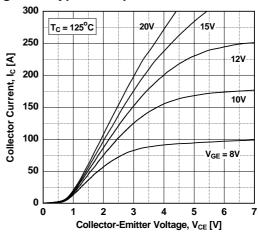


Figure 5. Saturation Voltage vs. Case
Temperature at Variant Current Level



**Figure 2. Typical Output Characteristics** 



**Figure 4. Transfer Characteristics** 

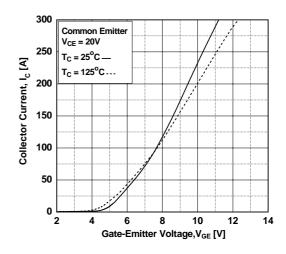


Figure 6. Saturation Voltage vs. V<sub>GE</sub>

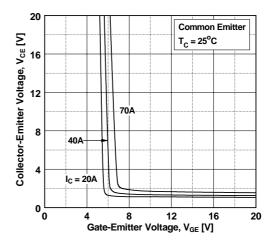


Figure 7. Saturation Voltage vs. V<sub>GE</sub>

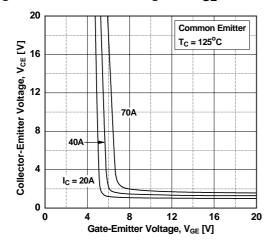


Figure 9. Gate charge Characteristics

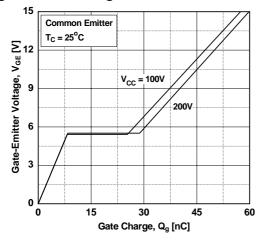
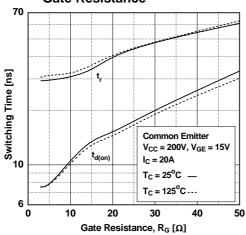


Figure 11. Turn-on Characteristics vs.
Gate Resistance



**Figure 8. Capacitance Characteristics** 

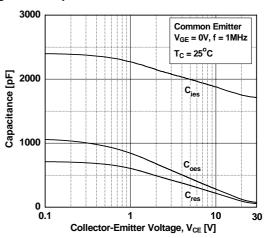


Figure 10. SOA Characteristics

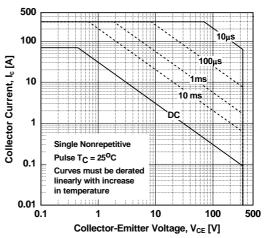


Figure 12. Turn-off Characteristics vs.
Gate Resistance

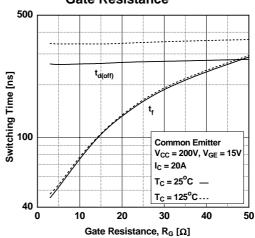


Figure 13. Turn-on Characteristics vs. Collector Current

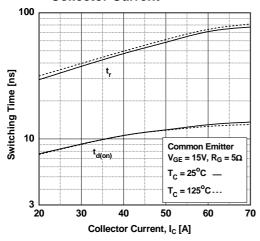


Figure 14. Turn-off Characteristics vs. Collector Current

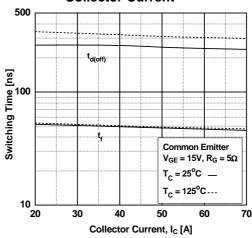


Figure 15. Switching Loss vs. Gate Resistance

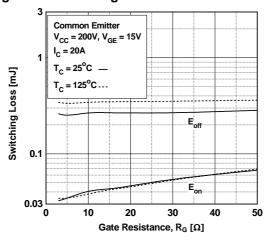


Figure 16. Switching Loss vs. Collector Current

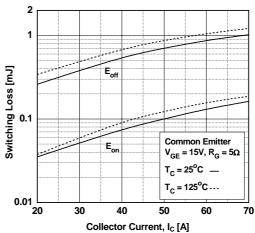
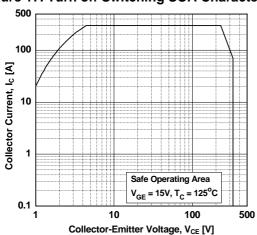
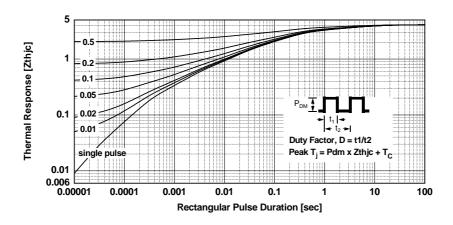


Figure 17. Turn off Switching SOA Characteristics

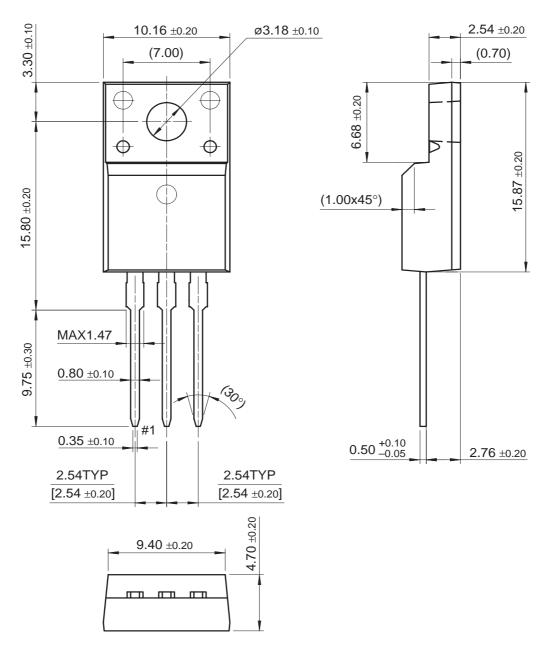






## **Package Dimensions**

# TO-220F Potted



\* Front/Back Side Isolation Voltage : AC 2700V

Dimensions in Millimeters





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